

# WaferSense®

Auto Gapping System™ (AGS)

AGS

## ○ Improve Uniformity and Yield with the Wireless WaferSense AGS for Accurate and Repeatable Setups

Speeds non-contact gap measurements and parallelism adjustments under vacuum for semiconductor processes such as thin-film deposition, sputtering and etch.



### **Achieve the ideal set-up for your equipment by measuring gaps at three points.**

- Quickly achieve exactly the gap you need, using the chamber readings at process pressure in numerical and graphical form, with the easy-to-use CyberSpectrum™ software.
- Achieve the best uniformity, whether you need to set a gap that is perfectly parallel or slightly tilted.

### **Improve tool-to-tool process uniformity with objective and repeatable gap adjustments.**

- Have peace of mind by taking the human variable out of adjusting your equipment.
- Make the right adjustments time after time.
- Enable anyone to set the same gap across the tools.

### **Reduce equipment calibration time through live feedback.**

- See the effects of adjustments in real-time.
- Have a clear indication when equipment settings are within tolerance using measurements that can be taken from inside an evacuated process chamber.

### **Speed setups, maintenance and troubleshooting with automatic handling.**

- Save time and expense.

**Semiconductor fabs and OEMs worldwide value the accuracy, precision and versatility of the WaferSense AGS – The most efficient and effective wireless measurement device for chamber gapping.**

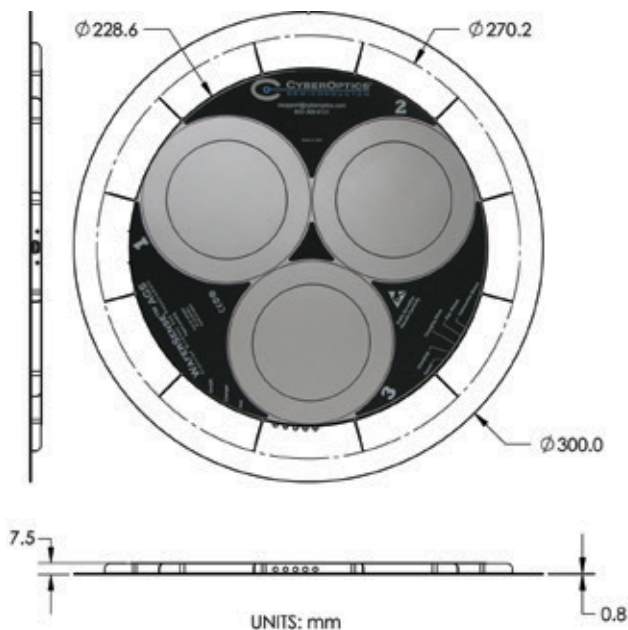


**Save Time. Save Expense. Improve Yields.**

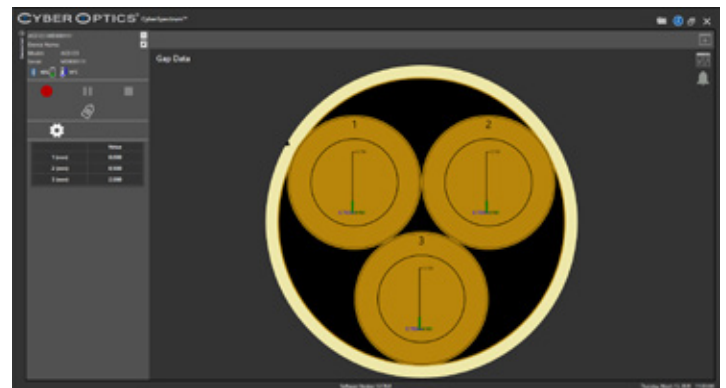
## Features

<b>Wireless, wafer-shaped and battery-powered</b>	Available in 200mm and 300mm
<b>Part Numbers</b>	AGS200 (200mm), AGS300 (300mm)
<b>Easy-to-use software</b>	CyberSpectrum software included CyberSpectrum: Displays real-time numerical and graphical data. Easily identify if it is above, below or within the target gap range. View log file data for review and analysis.
<b>Highly accurate</b>	Gap accuracy of $\pm 0.025$ with gaps of 15mm within 4 hours of field calibration Resolution of 0.005mm
<b>Durable housing</b>	Anodized aluminum
<b>Lightweight</b>	225 grams (200mm), 400 grams (300mm)
<b>Operating pressure</b>	$<10^{-6}$ to 760 torr
<b>Operating temperature</b>	20 to 70 degrees C
<b>Battery-operation</b>	>4 hrs. per charge, 8 hrs. typical
<b>WaferSense Link</b>	Bluetooth, 2.4 GHz, USB 1.1, dimensions 92mm x 58mm x 28mm
<b>Operating Systems</b>	Windows 7, 8, 10, or 11
<b>Product components</b>	Gapping measurement device, charging clean case, carrying suitcase, USB communications link module and application software
<b>Calibration</b>	Factory recalibration recommended annually
<b>Options</b>	AGS15 Fixture with a NIST traceable gap used to check/set AGS gap measurement accuracy

## Dimensions (AGS300)



## CyberSpectrum™



Real-time data.